٥C

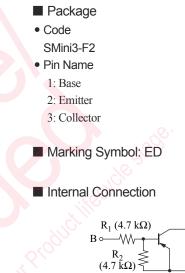
UNR51ALG

Silicon PNP epitaxial planar type

For digital circuits

- Features
- Costs can be reduced through downsizing of the equipment and reduction of the number of parts.
- SMini type package allowing easy automatic insertion through tape packing

| Absolute Maximum Ratings T _a | | Deting | 1 Juli |
|---|------------------|-------------|--------|
| Parameter | Symbol | Rating | Unit |
| Collector-base voltage (Emitter open) | V _{CBO} | -50 | V |
| Collector-emitter voltage (Base open) | V _{CEO} | -50 | V |
| Collector current | I _C | -80 | mA |
| Total power dissipation | P _T | 150 | mW |
| Junction temperature | Tj | 150 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |



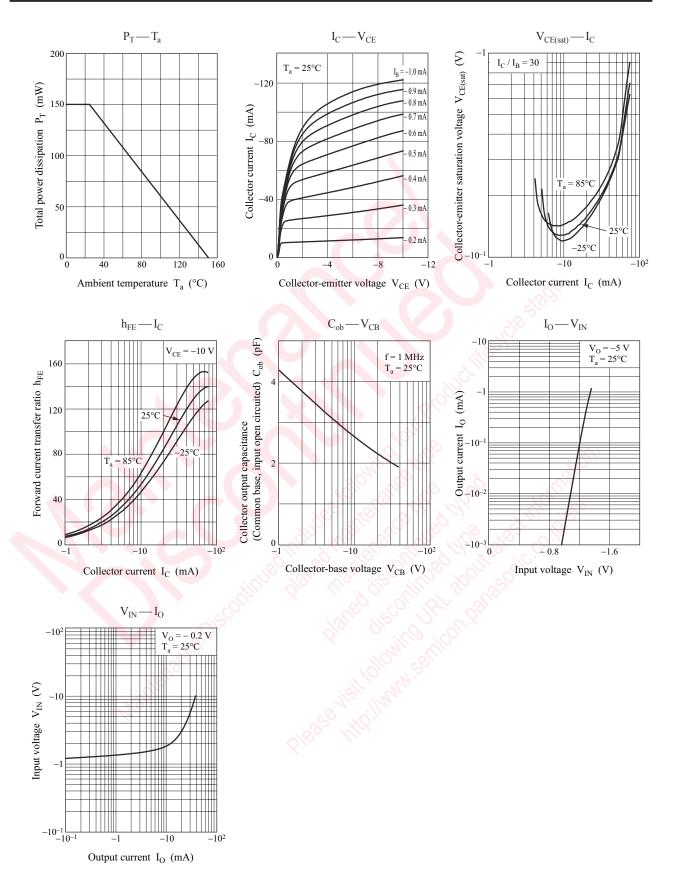
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------------------|---|------|------|--------|------|
| Collector-base voltage (Emitter open) | V _{CBO} | $I_{\rm C} = -10 \ \mu {\rm A}, I_{\rm E} = 0$ | -50 | 5000 | | V |
| Collector-emitter voltage (Base open) | V _{CEO} | $I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$ | -50 | | | V |
| Collector-base cutoff current (Emitter open) | ICBO | $V_{CB} = -50 \text{ V}, I_E = 0$ | | | - 0.1 | μΑ |
| Collector-emitter cutoff current (Base open) | I _{CEO} | $V_{\rm CE} = -50$ V, $I_{\rm B} = 0$ | | | - 0.5 | μΑ |
| Emitter-base cutoff current (Collector open) | I_{EBO} | $V_{\rm EB} = -6 \text{ V}, I_{\rm C} = 0$ | | | -2.0 | mA |
| Forward current transfer ratio | h _{FE} | $V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$ | 20 | | | |
| Collector-emitter saturation voltage | V _{CE(sat)} | $I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -0.3 \text{ mA}$ | | | - 0.25 | V |
| Output voltage high-level | V _{OH} | $V_{CC} = -5 V, V_B = -0.5 V, R_L = 1 k\Omega$ | -4.9 | | | V |
| Output voltage low-level | V _{OL} | $V_{CC} = -5 V, V_B = -2.5 V, R_L = 1 k\Omega$ | | | - 0.2 | V |
| Input resistance | R ₁ | | -30% | 4.7 | +30% | kΩ |
| Resistance ratio | R_1 / R_2 | | 0.8 | 1 | 1.2 | |
| Transition frequency | f_{T} | $V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$ | | 80 | | MHz |

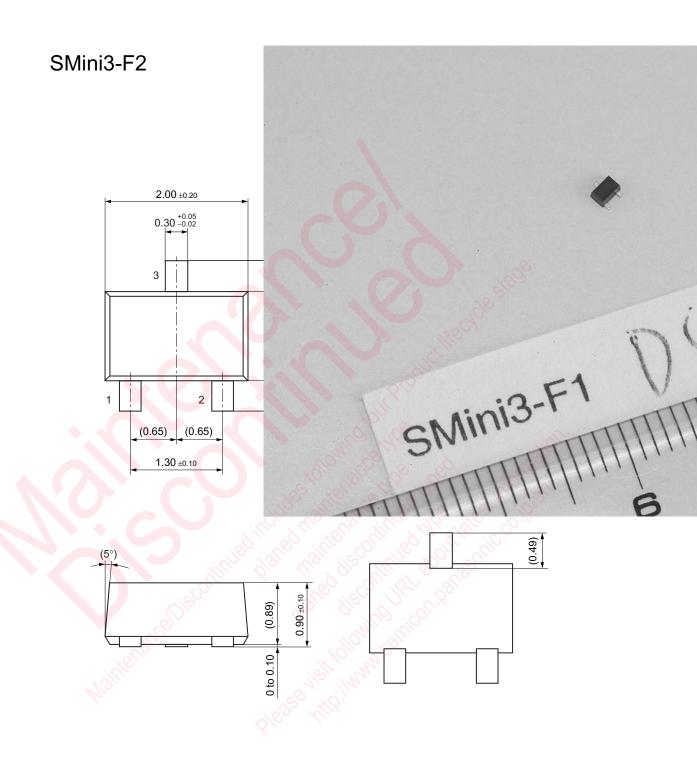
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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